## GenX3 ${ }^{\text {TM }} 300$ V IGBT IXGH60N30C3

## High Speed IGBTs for $50-150 \mathrm{kHz}$ switching

| Symbol | Test Conditions | Maximum Ratings |  |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {ces }}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ | 300 | V |
| $\mathrm{V}_{\mathrm{CGR}}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{GE}}=1 \mathrm{M} \Omega$ | 300 | V |
| $\mathrm{V}_{\text {GES }}$ | Continuous | $\pm 20$ | V |
| $\mathrm{V}_{\text {GEM }}$ | Transient | $\pm 30$ | V |
| $\mathrm{I}_{\text {c25 }}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ (Limited by leads) | 75 | A |
| $\mathrm{I}_{\mathrm{Cl10}}$ | $\mathrm{T}_{\mathrm{c}}=110^{\circ} \mathrm{C}$ (chip capability) | 60 | A |
| $\mathrm{I}_{\mathrm{CM}}$ | $\mathrm{T}_{\mathrm{c}}=25^{\circ} \mathrm{C}, 1 \mathrm{~ms}$ | 420 | A |
| $\mathrm{I}_{\mathrm{A}}$ | $\mathrm{T}_{\mathrm{c}}=25^{\circ} \mathrm{C}$ | 60 | A |
| $\mathrm{E}_{\text {AS }}$ | $\mathrm{T}_{\mathrm{c}}=25^{\circ} \mathrm{C}$ | 400 | mJ |
| SSOA <br> (RBSOA) | $V_{G E}=15 \mathrm{~V}, \mathrm{~T}_{\mathrm{VJ}}=125^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{G}}=5 \Omega$ <br> Clamped inductive load @ $\leq 300 \mathrm{~V}$ | $\mathrm{I}_{\text {CM }}=170$ | A |
| $\mathrm{P}_{\mathrm{c}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 300 | W |
| T, |  | $-55 \ldots+150$ | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {Jм }}$ |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ |  | $-55 \ldots+150$ | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Maximum lead temperature for soldering | 300 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {soLD }}$ | 1.6 mm (0.062 in.) from case for 10s | 260 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{M}_{\mathrm{d}}$ | Mounting torque (TO-247) | 1.13/10 | Nm/lb.in. |
| Weight |  | 6 | g |

## Symbol Test Conditions

Characteristic Values ( $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$, unless otherwise specified)

|  |  |  | Min. | Typ. | Max. |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \mathrm{BV}_{\text {cES }} \\ & \mathrm{V}_{\mathrm{GE}(\mathrm{th})} \\ & \hline \end{aligned}$ | $\begin{aligned} & I_{C}=250 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{GE}}=0 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{C}}=250 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CE}}=\mathrm{V}_{\mathrm{GE}} \end{aligned}$ |  | $\begin{array}{r} 300 \\ 2.5 \end{array}$ |  | 5.0 | V V |
| $\mathrm{I}_{\text {ces }}$ | $\begin{aligned} & V_{C E}=V_{C E S} \\ & V_{G E}=0 V \end{aligned}$ | $\mathrm{T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ |  |  | $\begin{array}{r} 30 \\ 750 \end{array}$ | $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {GES }}$ | $\mathrm{V}_{\mathrm{CE}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GE}}= \pm 20 \mathrm{~V}$ |  |  |  | $\pm 100$ | nA |
| $\mathrm{V}_{\text {CE(sat) }}$ | $\mathrm{I}_{\mathrm{C}}=60 \mathrm{~A}, \mathrm{~V}_{\mathrm{GE}}=15 \mathrm{~V}$ | $\mathrm{T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ |  | $\begin{aligned} & 1.55 \\ & 1.60 \end{aligned}$ | 1.8 | V |



TO-247 AD
(IXGH)

G = Gate
C = Collector
$\mathrm{E}=$ Emitter TAB = Collector

## Features

- High Frequency IGBT
- Square RBSOA
- High avalanche capability
- Drive simplicity with MOS Gate Turn-On
- High current handling capability


## Applications

- PFC Circuits
- PDP Systems
- Switched-mode and resonant-mode converters and inverters
- SMPS
- AC motor speed control
- DC servo and robot drives
- DC choppers



## ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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| IXYS MOSFETs and IGBTs are covered | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665 | 6,404,065 B1 | 6,683,344 | 6,727,585 | 7,005,734 B2 | 7,157,338B2 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| by one or moreof the following U.S. patents: | 4,850,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343 | 6,710,405 B2 | 6,759,692 | 7,063,975 B2 |  |
|  | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505 | 6,710,463 | 6,771,478 B2 | 7,071,537 |  |

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